





(2.00 mm) .0787"

N-PROFILE SMT HEADER

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?TMM

Insulator Material:

Black Liquid Crystal Polymer Terminal Material:

Phosphor Bronze

Plating: Sn or Au over 50 μ" (1.27 μm) Ni Current Rating: 3.2 A per pin

(2 pins powered)

Operating Temp Range:
-55 °C to +105 °C with Tin;
-55 °C to +125 °C with Gold

Voltage Rating: 281 VAC mated with SQW; 250 VAC mated with SQT

RoHS Compliant:

PROCESSING

Lead-Free Solderable:

SMT Lead Coplanarity:

(0.15 mm) .006" max* *(.004" stencil solution may be available; contact IPG@samtec.com)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



ALSO AVAILABLE (MOQ Required)

· Other platings

Note:

Some sizes, styles and options are non-standard, non-returnable.

Other Solutions

Throughhole



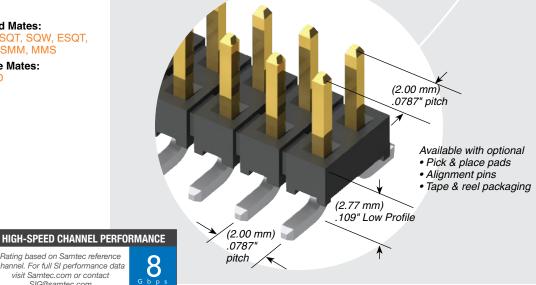
2 mm Shunt



Board Mates:

CLT, SQT, SQW, ESQT, TLE, SMM, MMS

Cable Mates:



Rating based on Samtec reference

channel. For full SI performance data visit Samtec.com or contact SIG@samtec.com

.078

PER ROW STYLE

NO. PINS

02 thru 40

No. of positions x (2.00) .0787

Specify LEAD **STYLE** from chart below.

LEAD

Gold flash on post Matte Tin on tail

PLATING

OPTION

= 10 µ" (0.25 µm) Gold on post, Matte Tin on tail

= 30 µ" (0.76 µm) Gold on post, Matte Tin on tail

> -Т = Matte Tin

-S = Single Row -D = Double Row

ROW

OPTION

= Alignment Pin (Metal or plastic at Samtec's discretion) (5 positions minimum) (-D only)

 SM

OTHER

OPTION

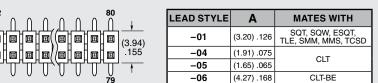
-"XXX"

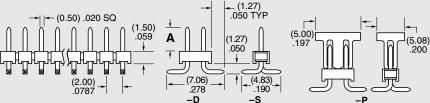
= Polarized Position (Specify position of omitted pin)

−P

= Pick & Place Pad (3 positions minimum)

−TR = Tape & Reel Packaging (3 thru 36 positions only)





Due to technical progress, all designs, specifications and components are subject to change without notice.

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Samtec:

TMM-140-01-G-S